

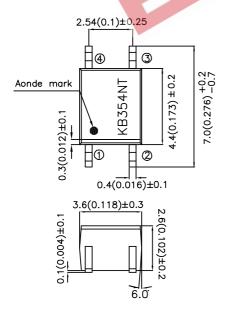
#### **Features**

- 1.AC inputs.
- 2. High current transfer ratio.
- 2. Opaque type, mini-flat package.
- 3. Subminiature type (The volume is smaller than that of our conventional DIP type by as far as 30%).
- 4. Isolation voltage between input and output Viso: 3750 Vrms.
- 5. Employs double transfer mold technology.
- 6. Recognized by UL and CUL, file NO. E225308.
- 7.Packge: 1000Pcs / Reel.
- 8.RoHS Compliant.

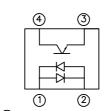
## **Applications**

- 1. Hybrid substrates that require high density mounting.
- 2. Programmable controllers.

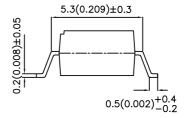
## \*PACKAGE DIMENSIONS (UNIT:mm) SMD Type



Internal connection diagram



- ① Anode/Cathode
- 2 Cathode/Anode
- 3 Emitter
- (4) Collector



UNIT: MM[INCH]

TOLERANCE: ±0.5[±0.02] UNLESS OTHERWISE NOTED.



## \*Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Rating	Unit	
	Forward current	lF	±50	mA	
Input	Power dissipation	Р	70	mW	
Output	Collector-emitter voltage	Vceo	35	V	
	Emitter-collector voltage	VECO	6	V	
	Collector current	IC	50	mA	
	Collector power dissipation	Pc	150	mW	
Total power dissipation		P tot	170	mW	
*1 Isolation voltage		V iso	3750	Vrms	
Operating temperature		T opr	-30 to +100	°C	
Storage temperature		T stg	-55 to +125	°C	
<sup>2</sup> Soldering temperature		T sol	260	°C	

<sup>\*1 40</sup> to 60%RH, AC for1 minute.

## \*Electro-optical Characteristics

Parameter		Symbol	Conditions	Min.	Тур.	Max.	Unit	
Input	Forward voltage		VF	IF=± 20mA	-	1.2	1.4	V
	Peak forward voltage		VFM	IFM=0.5A	-	-	3.0	V
Output	Collector dark current		ICEO	Vce=20V IF=0	-	-	10 <sup>-7</sup>	Α
	Collector-emitter breakdown voltage		BV <sub>CEO</sub>	I <sub>C</sub> =0.1mA IF=0	35	-	-	V
	Emitter-collector breakdown voltage		BV <sub>ECO</sub>	I <sub>E</sub> =10uA IF=0	6	-		V
Transfer charact-eristics	Current transfer ration		CTR	IF=± 1mA Vce=5V	20	-	400	%
	Collector-emitter saturation voltage		VCE (sat)	IF=± 20mA IC=1mA	-	0.1	0.2	V
	Response time Fall time	Rise time	tr	Vce=2V IC=2mA	-	4	18	uS
		tr	RL=100Ω		3	18	uS	

Model No.	Rank mark	CTR(%)		
KB354N1T	Α	50 to 150		
KB354NT	A or No mark	20 to 400		

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<sup>\*2</sup> For 10 seconds.

# Kingbright

## KB354NT

Fig. 1 Current Transfer vs. Forward Current

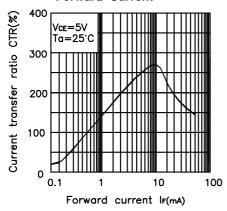


Fig. 2 Forward Current vs. Forward voltage

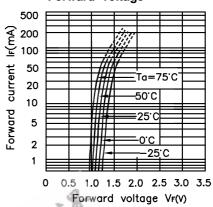


Fig. 3 Collector Current vs.
Collector-emitter Voltage

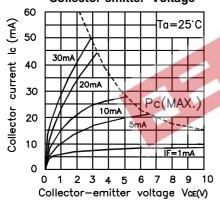


Fig. 4 Forward Current vs.

Ambient Temperature

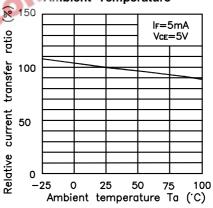


Fig. 5 Collector-emitter Saturation Voltage vs. Ambient Temperature

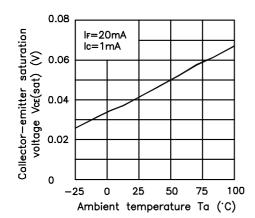
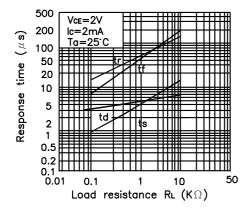




Fig. 6 Response Time vs. Load Resistance



Test Circuit for Response Time

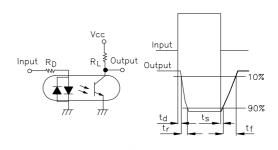


Fig. 7 Collector-emitter Saturation Voltage vs. Forward Current

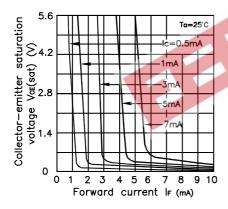
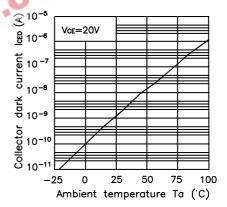


Fig. 8 Collector Dark Current vs.
Ambient Temperature



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#### \* NOTES ON HANDLING

1.Recommended soldering conditions (Dip soldering)

#### (1) Dip soldering

Temperature 260°C or below (molten solder temperature)

Time Less than 10 seconds.

Cycle One cycle allowed to be dipped in solder including plastic nold portion.

Flux Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

## (2) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

#### 2. Cautions regarding noise

Be aware that power is suddenly into the component any surge current may cause damage happen, even if the voltage is within the absolute maximum ratings.

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#### NOTES ON HANDLING

1.Recommended soldering conditions

(1).Infrared reflow soldering

Peak reflow temperature
 235 ° C or below(package surface temperature)

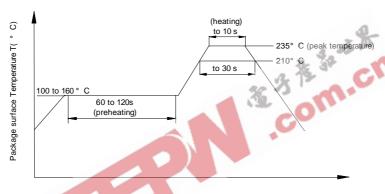
• Time of temperature higher than 210 ° C 30 seconds or less

Number or reflows
 Three

• Flux Rosin flux containing small amount of chlorine(The flux with a

maximum chlorine content of 0.2Wt % is recommended.)

Recommended Temperature Profile of infrared Reflow



#### CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested.

GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them.

#### RESTRICTIONS ON PRODUCT USE

- The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all devices / types available in every country.
- We are mention about our product quality stablity, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing KINGBRIGHT products, to observe standards of safety, and to a avoid situations in which a malfunction or failure of a KINGBRIGHT product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that KINGBRIGHT products are used within specified operating ranges as set forth in the most recent products specifications.

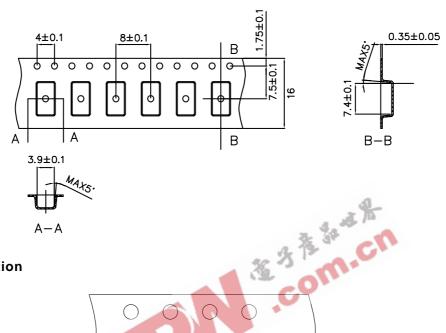
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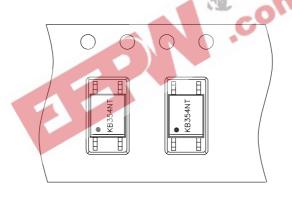


#### Outline and Dimension(Tape)

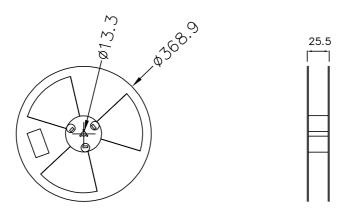
(Units: mm)



#### **Tape Direction**



#### Outline and Dimension(Reel)



Packing:1000pcs/reel